

Changes in automotive low/mid power portfolio

Customer Info Package for:
OS-PDN-2022-13: HOP/Classic - changes in automotive low/mid power portfolio
Status: June 2022

OS AM INT

Discontinuation of outdated InGaAlP chip technology and low volume devices

Motivation and Impact

Motivation

- Reduce complexity in value chain
- Short term discontinuations
- Streamline the product portfolio
- Not for new design - OS-NFND-2021-018 – published by ams-OSRAM
- Short term discontinuations

Affected Devices:

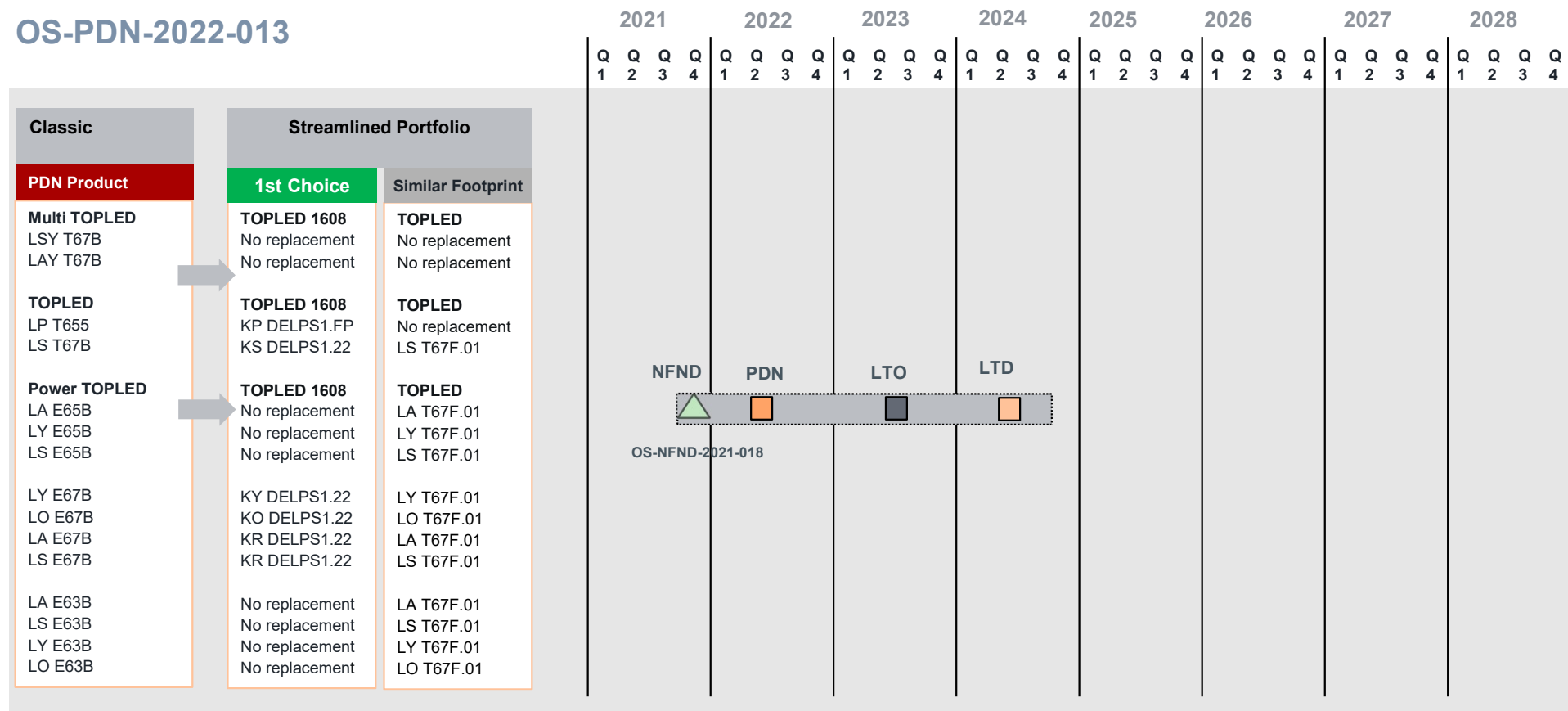
TOPLED	Mini TOPLED	Power TOPLED	SIDELED	Multi TOPLED
LS T67B	LP M675	LA E65B	LS A676	LSY T67B
LP T655		LY E65B	LY A676	LAY T67B
ZS T676		LS E65B	LO A67K	
ZY T676		LY E67B	LS A67K	
ZP T676		LO E67B	LY A67K	
		LA E67B	LG A67K	
		LS E67B	LP A675	
		LA E63B	LY A67B	
		LS E63B		
		LY E63B		
		LO E63B		

Discontinuation of outdated InGaAIP chip technology and low volume devices

Timeline for TOPLED / Power TOPLED and Multi TOPLED with HOP chip technology

△ NFND ■ PDN ■ LTO ■ LTD

OS-PDN-2022-013

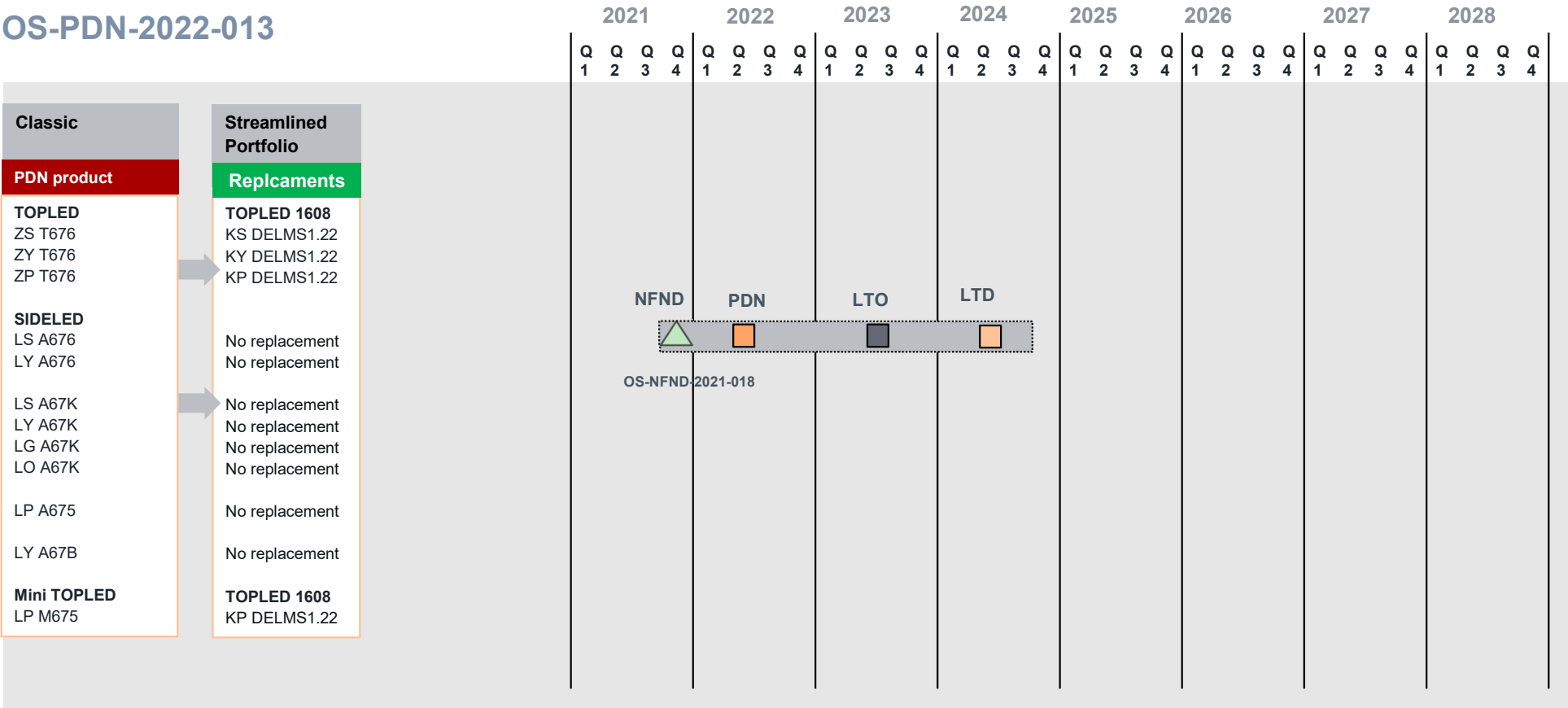


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Timeline TOPLED / Mini TOPLED / SIDELED

△ NFND ■ PDN ■ LTO ■ LTD

OS-PDN-2022-013



Sensing is life

ami OSRAM

Thank you

For internal use